476-1859

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN THE APPLICATION OF	
Philip Andrew Anslow et al.)
SERIAL NO: To be assigned)
FILED: Herewith)
FOR: High Density Printed Wiring Board Having In-Via Surface Mounting Pads))

CLAIM FOR PRIORITY

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

Dear Sir:

Under the International Convention, for the purposes of priority, applicant claims the benefit of the United Kingdom Application No. 9828656.0, filed December 23, 1998.

A certified copy of said application is appended hereto.

DATE: November 30, 1999

Respectfully submitted,

Registration No. 26,935

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ARTIFACT SHEET

Indicate quantity of item(s) received by the USPTO but not scanned.

X	Priority Document No. 9828656.0 Country UK Doc Code: FRPR
	CD(s) containing computer program listing Doc Code: Computer
	Stapled Set(s) of Extra Color Drawings Doc Code: Artifact
	CD(s) containing pages of specification and/or sequence listing Doc Code: Artifact
	CD(s) with content unspecified Doc Code: Artifact
	Microfilm(s) Doe Code: Artifact
	Video tape(s) Doc Code: Artifact
	Other mass storage media, description: Doc Code: Artifact
	Model(s) Doc Code: Artifact
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